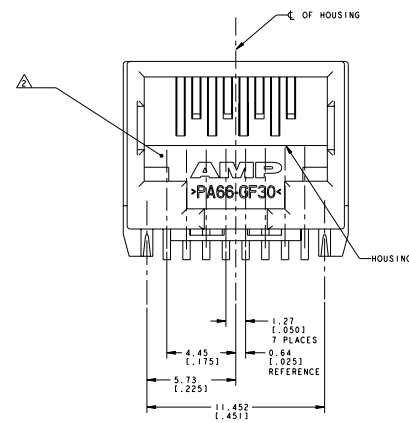
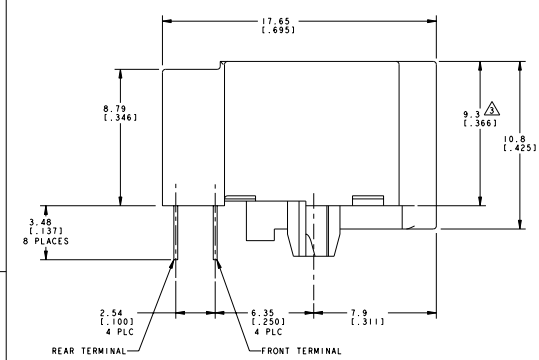
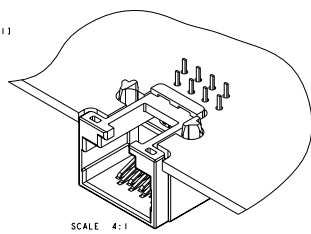
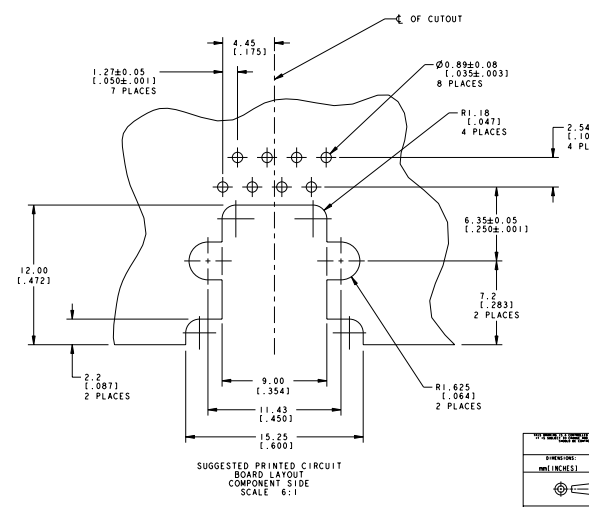
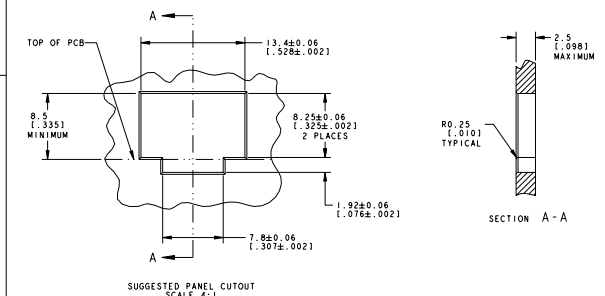
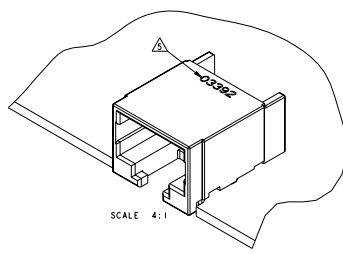
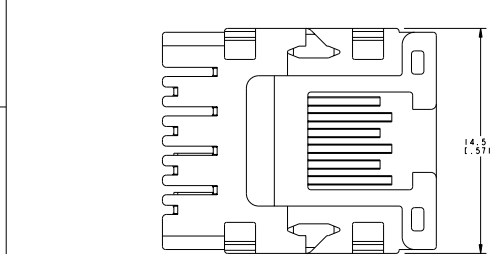


| REV | DATE | DESCRIPTION | BY | CHK | APP |
|-----|----------------|-------------|----------|------|------|
| G | EC0511-0147-03 | | 14EY2004 | LAN | BA |
| H | EC0511-0025-04 | | 2705P004 | LAN | BA |
| J | ECR-08-020444 | | 2705P004 | LAN | JW |
| K | ECR-08-012923 | | 14EY2004 | A.I. | S.T. |



- ⚠ MATERIAL: HOUSING - HIGH TEMPERATURE NYLON, BLACK, UL 94V-0, IR REFLOW SOLDERING PROCESS COMPATIBLE
 TERMINALS - 0.25(.010) THICK PHOSPHOR BRONZE PLATED WITH 3.81µm(.000150) MINIMUM THICK BRIGHT TIN-LEAD IN SOLDER AREA, 1.27µm(.000050) MINIMUM GOLD IN LOCALIZED PLATE AREA, ENTIRE TERMINAL PLATED WITH 1.27µm(.000050) MINIMUM THICK NICKEL.
- ⚠ JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
- ⚠ THIS DIMENSION REPRESENTS THE TOTAL HEIGHT OF THE CONNECTOR FROM THE TOP OF THE PC BOARD.
- 4. PACKAGED 66 ASSEMBLIES PER PVC TRAY, 396 PER BOX.
- ⚠ MANUFACTURING DATE CODE:
 ORIENTED AND LOCATED APPROXIMATELY AS SHOWN, BLACK INK STAMP, TEXT HEIGHT APPROXIMATELY 2MM.
 FIRST 2 DIGITS = LAST 2 DIGITS OF YEAR
 NEXT 2 DIGITS = MANUFACTURING WORK WEEK
 LAST DIGIT = DAY OF WEEK WITH SUNDAY = 1
- ⚠ MATERIAL: HOUSING - HIGH TEMPERATURE NYLON, BLACK, UL 94V-0, IR REFLOW SOLDERING PROCESS COMPATIBLE
 TERMINALS - 0.25(.010) THICK PHOSPHOR BRONZE PLATED WITH 3.81µm(.000150) MINIMUM THICK MATTE TIN IN SOLDER AREA, 1.27µm(.000050) MINIMUM GOLD IN LOCALIZED PLATE AREA, ENTIRE TERMINAL PLATED WITH 1.27µm(.000050) MINIMUM THICK NICKEL.



OBSOLETE

| | |
|-----------|--|
| 1116504-2 | |
| 1116504-1 | |

MATERIAL / FINISH: PART NUMBER

TECH ELECTRONICS CORPORATION
 Harrisburg, PA 17105-3600

MODULAR JACK ASSEMBLY,
 8 POSITION, 10mm

DATE: 11-4-2008
 WEIGHT: 3.49 grams
 CUSTOMER DRAWING: 00778 © 1116504

SCALE: 8:1